

250W FLIP CHIP TVS ARRAY

DESCRIPTION

The P0406FCxxC Series Flip Chips employ advanced silicon P/N junction technology for unmatched board-level transient voltage protection against Electrostatic Discharge (ESD) and Electrical Fast Transients (EFT). Developed specifically for high-density circuit protection, this series meets the IEC 61000-4-2 and 61000-4-4 requirements. These devices are ideally suited for handheld devices, PCMCIA and SMART cards.

This series provides ESD protection greater than 25 kilovolts with a peak pulse power dissipation of 250 Watts per line for an 8/20µs waveform. In addition, the P0406FCxxC series features superior clamping performance, low leakage current characteristics and a response time of less than a nanosecond. Their low inductance virtually eliminates overshoot voltage due to package inductance.

FEATURES

- Compatible with IEC 61000-4-2 (ESD): Air 15kV, Contact 8kV
- Compatible with IEC 61000-4-4 (EFT): 40A, 5/50ns
- ESD Protection > 25 kilovolts
- Available in Voltages Ranging from 3.3V to 36V
- 250 Watts Peak Pulse Power per Line (tp = 8/20μs)
- Protection for 3 to 5 Lines
- RoHS Compliant
- REACH Compliant

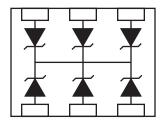
MECHANICAL CHARACTERISTICS

- Standard EIA Chip Size: 0406
- Approximate Weight: 0.73 milligrams
- Lead-Free Plating
- Solder Reflow Temperature:
- Lead-Free Sn/Ag/Cu, 96/3.5/0.5: 260-270°C
- Flammability Rating UL 94V-0
- 8mm Tape per EIA Standard 481
- Top Contacts: Solder Bump 0.004" in Height (Nominal)

APPLICATIONS

- Cellular Phones
- MCM Boards
- Wireless Communication Circuits
- IR LEDs
- SMART & PCMCIA Cards

PIN CONFIGURATION



TYPICAL DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified								
PARAMETER SYMBOL VALUE UNITS								
Peak Pulse Power (tp = 8/20µs) - See Figure 1	P _{pp}	250	Watts					
Operating Temperature	T _A	-55 to 150	°C					
Storage Temperature	Т _{stg}	-55 to 150	°C					

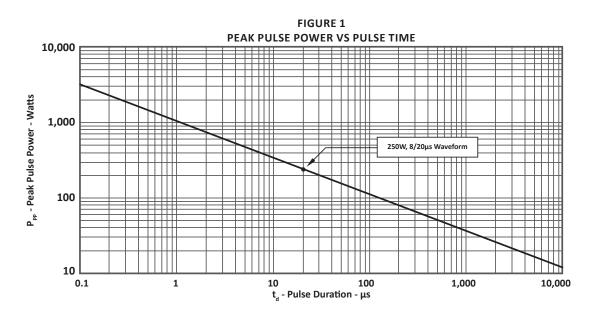
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified								
PART NUMBER (Note 1)	RATED STAND-OFF VOLTAGE V _{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE @ 1mA V _(BR) VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ I _p = 1A V _c VOLTS	MAXIMUM CLAMPING VOLTAGE (Fig. 2) @ 8/20µS V _c @ I _{PP}	MAXIMUM LEAKAGE CURRENT (Note 2) @V _{WM} Ι _D μΑ	TYPICAL CAPACITANCE @0V, 1MHz C pF		
P0406FC3.3C	3.3	4.0	7.0	12.5V @ 20A	75*	150		
P0406FC05C	5.0	6.0	11.0	14.7V @ 17A	10**	100		
P0406FC08C	8.0	8.5	13.2	19.2V @ 13A	10***	75		
P0406FC12C	12.0	13.3	19.8	29.7V @ 9A	1	50		
P0406FC15C	15.0	16.7	25.4	35.7V @ 7A	1	40		
P0406FC24C	24.0	26.7	37.2	55.0V @ 5A	1	30		
P0406FC36C	36.0	40.0	70.0	84.0V @ 3A	1	25		

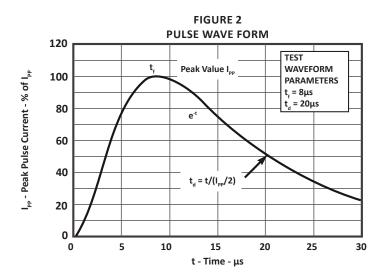
NOTES

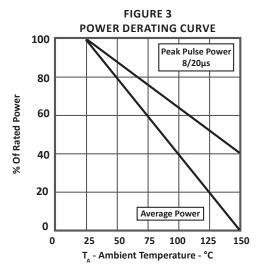
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All devices are bidirectional. Electrical characteristics apply in both directions.
*Maximum leakage current < 5μA @ 2.8V. **Maximum leakage current < 500nA @ 3.3V. ***Maximum leakage current < 200nA @ 5V.

TYPICAL DEVICE CHARACTERISTICS





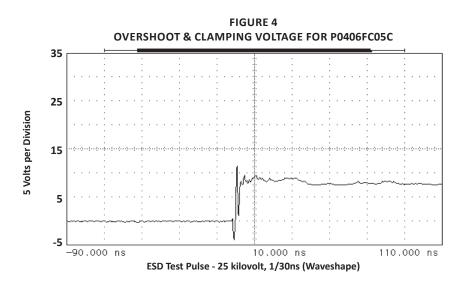


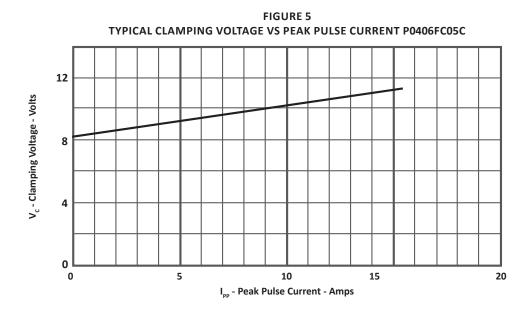
TYPICAL DEVICE CHARACTERISTICS

PROJEK DEV

ICES

Only One Name Means ProTek'Tion™



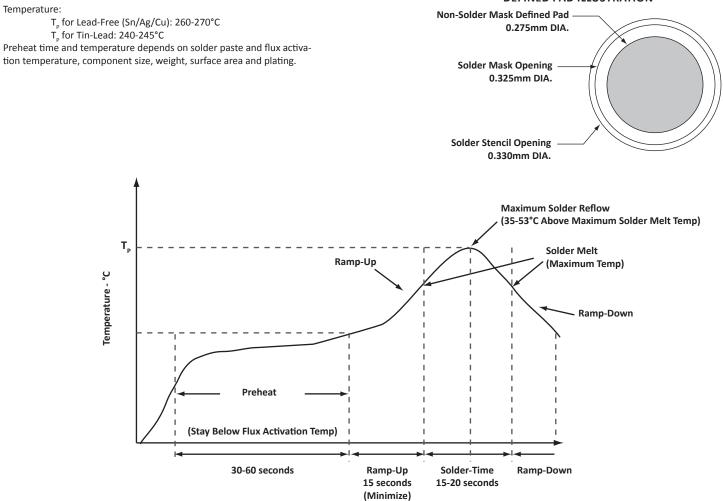


SOLDER REFLOW INFORMATION

PRINTED CIRCUIT BOARD RECOMMENDATIONS						
PARAMETER	VALUE					
Pad Size on PCB	0.275mm					
Pad Shape	Round					
Pad Definition	Non-Solder Mask Defined Pads					
Solder Mask Opening	0.325mm Round					
Solder Stencil Thickness	0.150mm					
Solder Stencil Aperture Opening (Laser cut, 5% tapered walls)	0.330mm Round					
Solder Paste Type	No Clean					
Pad Protective Finish	OSP (Entek Cu Plus 106A)					
Tolerance - Edge To Corner Ball	±50µm					
Solder Ball Side Coplanarity	±20µm					
Maximum Dwell Time Above Liquidous (183°C)	60 seconds					
Soldering Maximum Temperature	270°C					

REQUIREMENTS

RECOMMENDED NON-SOLDER MASK DEFINED PAD ILLUSTRATION



0406 PACKAGE INFORMATION

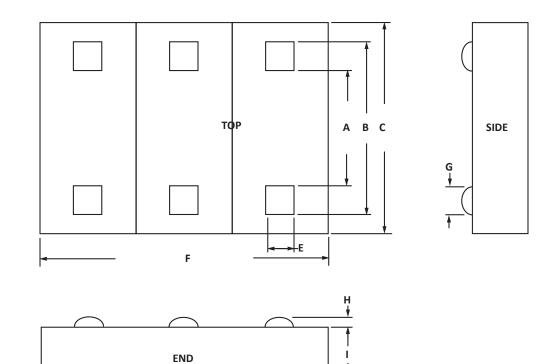
OUTLINE DIMENSIONS								
	MILLIN	IETERS	INCHES					
DIM	MIN	MAX	MIN	MAX				
А	0.!	0.56 0.022						
В	0.8	86	0.034					
С	0.98	1.02	0.038	0.040				
E	0.15	5 SQ	0.00	6 SQ				
F	1.47	1.53	0.058	0.060				
G	0.:	15	0.006					
н	0.076	0.127	0.003	0.005				
I .	0.4	106	0.016					
NOTES								

NOTES

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1. Controlling dimensions in inches.

2. Decimal tolerance: .xxx \pm 0.05mm (0.002").



P0406FC3.3C - P0406FC36C

0406 PACKAGE INFORMATION

OPTION 1 - LAYOUT DIMENSIONS							
	MILLIMETERS	INCHES					
DIM	NOMINAL	NOMINAL					
А	0.51	0.020					
С	0.30	0.012					
D	0.46	0.018					
E	0.20	0.008					
F	0.15 SQ	0.006 SQ					
G	0.71	0.028					
н	0.99	0.039					
I	0.51	0.020					
NOTES							

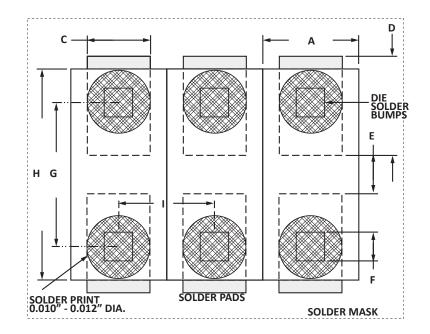
NOTES

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1. Controlling dimensions in inches.

2. Decimal tolerance: .xxx \pm 0.05mm (0.002").

3. Preferred: Usign 0.1mm (0.004") stencil.



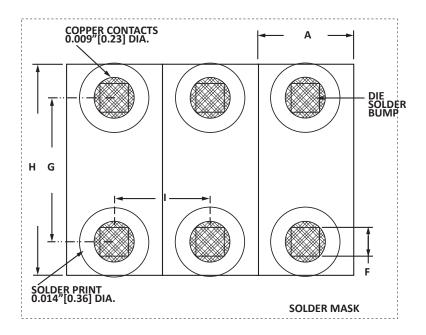
OPTION 2 - LAYOUT DIMENSIONS							
DIM	MILLIMETERS	INCHES					
DIM	NOMINAL	NOMINAL					
А	0.51	0.020					
F	0.15 SQ	0.006 SQ					
G	0.71	0.028					
н	0.99	0.039					
I	0.51	0.020					

NOTES

1. Controlling dimensions in inches.

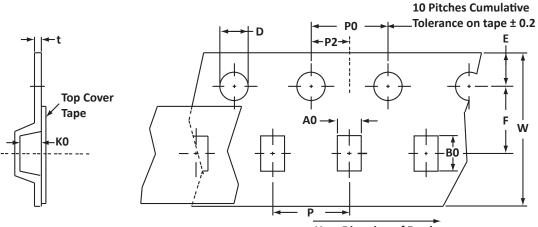
2. Decimal tolerance: .xxx \pm 0.05mm (0.002").

3. Preferred: Usign 0.1mm (0.004") stencil.



TAPE AND REEL INFORMATION

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User Direction of Feed

SPECIFICATIONS											
REEL DIA. TAPE WIDTH	A0	В0	ко	D	E	F	w	PO	P2	Р	Tmax
178(7") 8	0.80 ± 0.10	1.20 ± 0.10	0.70 ± 0.10	1.50 ± 0.10	1.75 ± 0.10	3.50 ± 0.05	8.00 ± 0.20	4.00 ± 0.12	2.00 ± 0.05	2.00 ± 0.10	0.25
178(7") 8 0.80 ± 0.10 1.20 ± 0.10 0.70 ± 0.10 1.75 ± 0.10 3.50 ± 0.05 8.00 ± 0.20 4.00 ± 0.12 2.00 ± 0.05 2.00 ± 0.10 0.25 NOTES 1. Dimensions in millimeters. 2. Top view of tape. Solder bumps are face down in tape package. 3. Orientation: preferred stencil - 0.1mm (0.004"). 4. Surface mount product is taped and reeled in accordance with EIA 481. 5. 8mm plastic tape: 7" Reels - 5,000. 6. Marking on reel: part number, date code and lot number.											

ORDERING INFORMATION									
BASE PART NUMBER (xx = Voltage) LEADFREE SUFFIX TAPE SUFFIX QTY/REEL REEL SIZE TU									
P0406FCxxC	-LF	-T75-1	5,000	7″	n/a				
This device is only available in a Lead-Free configuration.									

COMPANY INFORMATION

COMPANY PROFILE

In business more than 20 years, ProTek Devices[™] is a privately-held company located in Tempe, Arizona, that offers a product line of transient voltage suppressors (TVS); avalanche breakdown diodes; steering diode TVS arrays and other surge suppressor component products. These TVS devices protect electronic systems from the effects of lightning, electrostatic discharge (ESD), nuclear electromagnetic pulses (NEMP), inductive switching and EMI / RFI. ProTek Devices also offers high performance interface and linear products that include analog switches; multiplexers; LED drivers; audio control ICs; RF and related high frequency products. The analog devices work in a host of consumer; industrial; automotive and other applications.

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PATENT INFORMATION: This device is patented under U.S. Patent No. Des. "D456,367S".